

CORRECTION

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Correction: Advanced Atomic Layer Deposition Technologies for Micro-LEDs and VCSELs

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Correction to: *Nanoscale Research Letters* (2021) 16:164

<https://doi.org/10.1186/s11671-021-03623-x>

Following publication of the original article, it was brought to the authors' attention that one of the funding names in the funding list had been left out.

Namely, the information in the Funding declaration: "This research was supported by the National Natural Science Foundation of China (11,904,302), Science and Technology Plan Project in Fujian Province of China (2021H0011), Major Science and Technology Project of Xiamen, China (3502Z20191015), and Hong Kong University of Science and Technology - oshan Joint Research Program (FSUST19-FYTRI11)", had been incorrectly written as "This research was supported by the National Natural Science Foundation of China (11904302), Science and Technology Plan Project in Fujian Province of China (2021H0011), and Major Science and Technology Project of Xiamen, China (3502Z20191015)."

The error has since been corrected in the original article.

The authors apologize for any inconvenience caused.

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Published online: 07 February 2022

Publisher's Note

Springer Nature remains neutral with regard to jurisdictional claims in published maps and institutional affiliations.

The original article can be found online at <https://doi.org/10.1186/s11671-021-03623-x>.

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